#### 

# PJQ5413

#### 30V P-Channel Enhancement Mode MOSFET

Voltage

Current -25 A

DFN5060-8L

03

#### Features

- $R_{DS(ON)}$ ,  $V_{GS}$ @-10V,  $I_D$ @-4A<30m $\Omega$
- $R_{DS(ON)}$ ,  $V_{GS}$ @-4.5V,  $I_D$ @-2A<45m $\Omega$

-30 V

- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

- Case : DFN5060-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.0028 ounces, 0.08 grams

**Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	-30	Ň	
Gate-Source Voltage		$V_{GS}$	<u>+</u> 20	V	
Continuous Drain Current (Note 4)	T <sub>C</sub> =25°C		-25		
	T <sub>C</sub> =100°C	ID	-16	А	
Pulsed Drain Current (Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	-50		
Power Dissipation	T <sub>C</sub> =25°C		30		
	$T_{\rm C}=100^{\circ}{\rm C}$	PD	12	W	
Continuous Drain Current (Note 4)	T <sub>A</sub> =25°C		-6.5		
	T <sub>A</sub> =70°C	I <sub>D</sub>	-5	A	
Power Dissipation	T <sub>A</sub> =25°C		2		
	T <sub>A</sub> =70°C	PD	1.3	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~150	°C	
Typical Thermal Resistance (Note 4,5)	Junction to Case	R <sub>θJC</sub>	4.2	00.000	
	Junction to Ambient	$R_{\theta JA}$	62.5	°C/W	



#### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

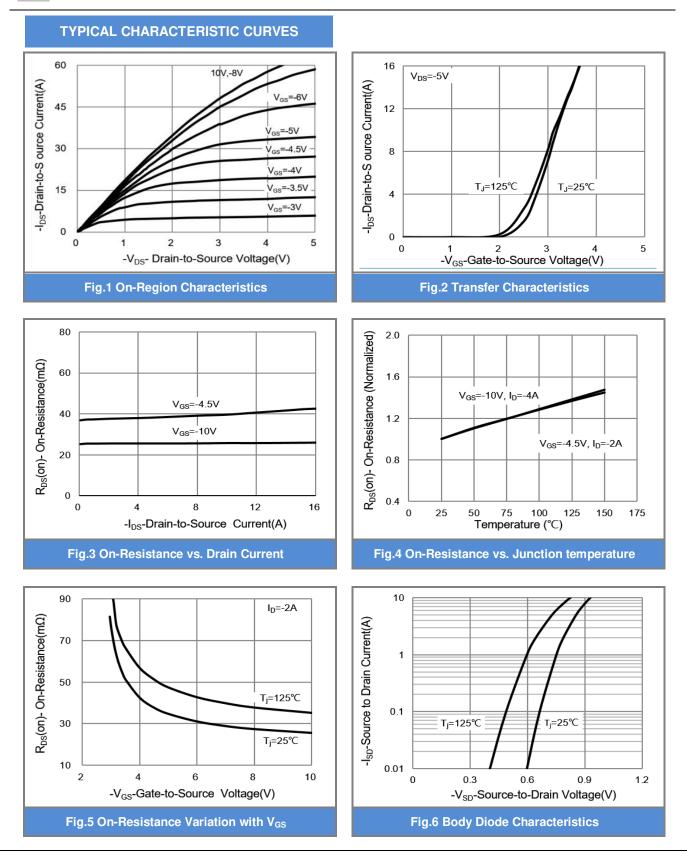
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$BV_{DSS}$ $V_{GS}=0V, I_D=-250uA$	-30	-	-	v
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250$ uA	-1	-1.6	-2.5	v
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS}$ =-10V, $I_{D}$ =-4A	-	26	30	mΩ
		$V_{GS}$ =-4.5V, $I_{D}$ =-2A	-	36	45	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-30V, $V_{GS}$ =0V	-	-	-1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 20V, V <sub>DS</sub> =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 6)						
Total Gate Charge	Qg	$V_{DS}$ =-15V, I <sub>D</sub> =-5A, V <sub>GS</sub> =-4.5V <sup>(Note 1,2)</sup>	-	7.8	-	nC
Gate-Source Charge	$Q_gs$		-	2.7	-	
Gate-Drain Charge	$Q_gd$		-	2.8	-	
Input Capacitance	Ciss	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHZ	-	870	-	pF
Output Capacitance	Coss		-	130	-	
Reverse Transfer Capacitance	Crss		-	93	-	
Turn-On Delay Time	td <sub>(on)</sub>		-	6.5	-	ns
Turn-On Rise Time	tr	V <sub>DS</sub> =-15V, I <sub>D</sub> =-1A, V <sub>GS</sub> =-10V, R <sub>G</sub> =6Ω (Note 1.2)	-	8.8	-	
Turn-Off Delay Time	td <sub>(off)</sub>		-	73	-	
Turn-Off Fall Time	t <sub>f</sub>		-	44	-	
Drain-Source Diode						
Maximum Continuous Drain-Source			-	-	-25	Α
Diode Forward Current	I <sub>S</sub>					
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =-1A, V <sub>GS</sub> =0V	-	-0.75	-1	V

NOTES :

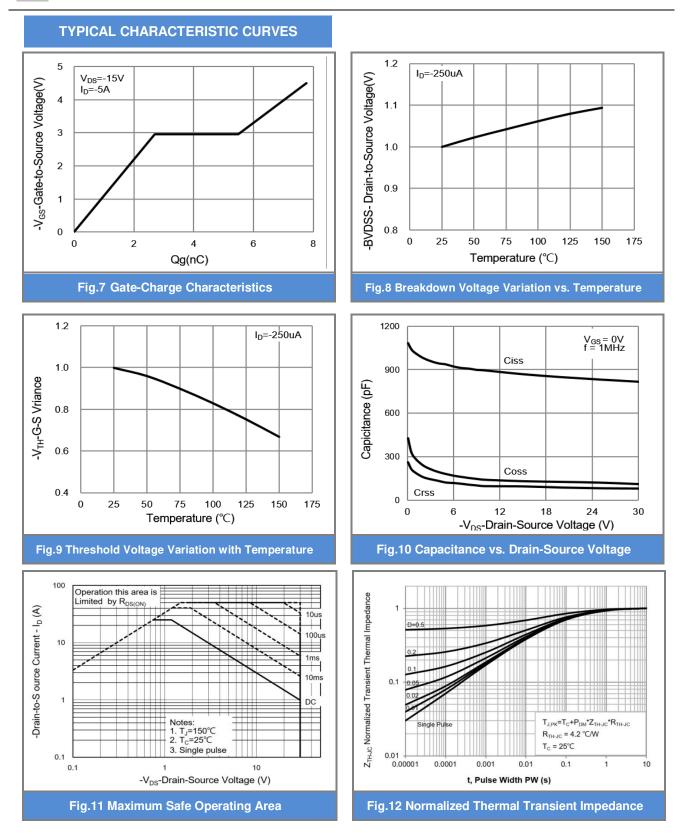
- 1. Pulse width</br>200us, Duty cycle2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}=150$  °C. Ratings are based on low frequency and duty cycles to keep initial  $T_J=25$  °C.
- 4. The maximum current rating is package limited.
- 5. Reua is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing.











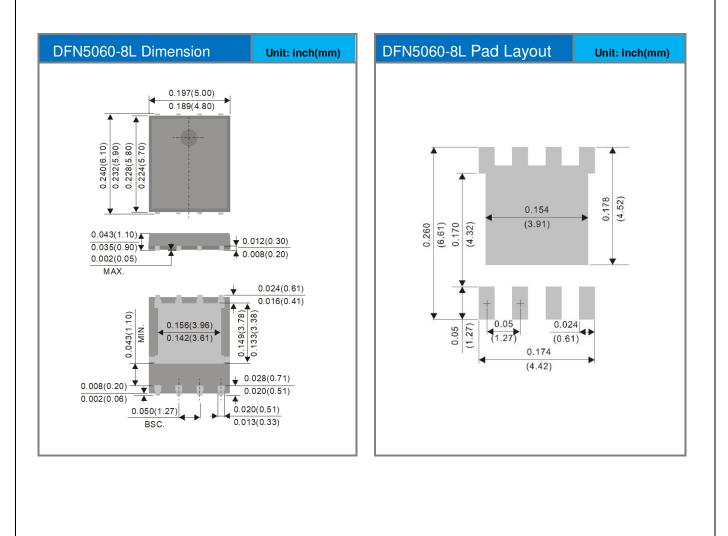




#### Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJQ5413_R2_00001	DFN5060-8L	3000pcs / 13" reel	Q5413	Halogen free

#### Packaging Information & Mounting Pad Layout





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